

Special Issue

3D Printed Sensors and Actuators

Message from the Guest Editor

With recent advances in digital fabrication and materials science, devices capable of performing multifunctional sensing can be readily fabricated in cost-effective manners via 3D printing and related technologies in digital fabrication. This Special Issue of *Sensors* aims to provide a collection of approaches and strategies that highlight the advantages, limitations, and current challenges in this emerging field. The issue focuses on fabrication, materials, and applications in the field, including micro-and millifluidic devices, wearable devices, diagnostic tools, flexible sensors, smartphone interfaces, and so forth. Authors are invited to submit both original research articles and reviews.

Guest Editor

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Deadline for manuscript submissions

closed (31 July 2020)



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Message from the Editor-in-Chief

Sensors is a leading journal devoted to fast publication of the latest achievements of technological developments and scientific research in the huge area of physical, chemical and biochemical sensors, including remote sensing and sensor networks. Both experimental and theoretical papers are published, including all aspects of sensor design, technology, proof of concept and application. Sensors organizes Special Issues devoted to specific sensing areas and applications each year.

Editor-in-Chief

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